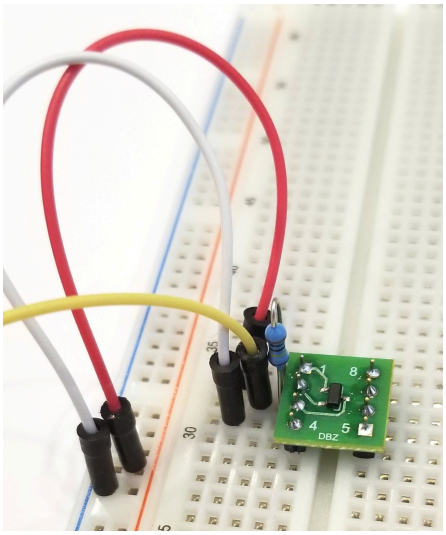
HALL-ADAPTER-EVM Usage Instructions



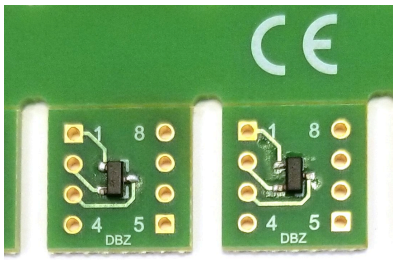
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The HALL-ADAPTER-EVM simplifies prototyping SMT ICs:

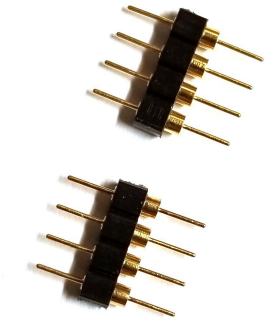
The HALL-ADAPTER-EVM supports SOT23-3 (DBZ), TO-92 (LPG), X2SON (DMR), SOT23-5/6 (DBV), DSBGA (YBH) and MSOP-8 (DGK) packages.



Usage Instructions:

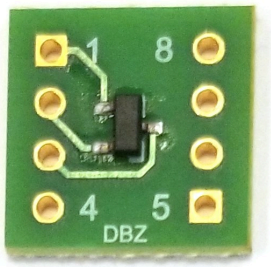


Step 1: Solder IC(s) to adapter PCB. Parts may be hand soldered or attached with IR or hot air reflow techniques.

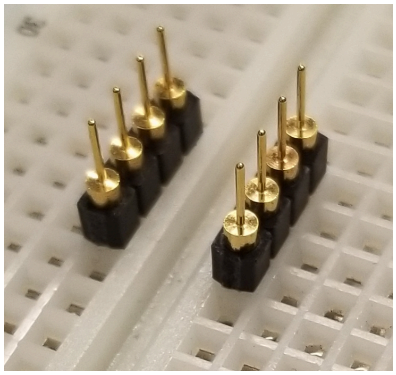


Step 2: Use long nose pliers to snap terminal strips (Samtec part number TSW-124-07-L-S) into 4 position lengths.

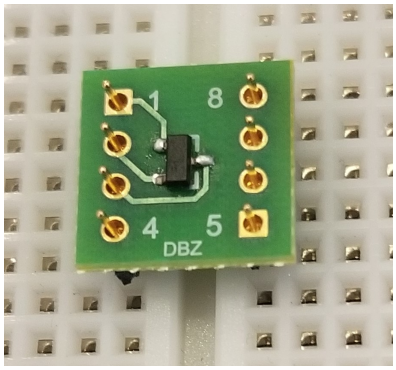
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Step 3: Gently flex panel at score lines to separate boards.



Step 4: Insert terminal strips into a breadboard or spare DIP socket to align pins.



Step 5: Position board over pins and solder the connections. Carefully remove from breadboard or DIP socket and complete.

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Changes from Original (November 2017) to A Revision **Page**

- Changed *Usage Instructions* format to follow other ADAPTER-EVM guides..... 1

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